

AMENDMENTS TO THE SPECIFICATION

IN THE SPECIFICATION:

Page 3

Please amend paragraph [0007] to read as follows:

[0007] As described in Patent Document 3 (~~JP 2000-100621-A~~) (JP 2001-100621-A), there is known a method in which the shape made of the photosensitive material is molded with a resin such as epoxy resin or a metal by electrotyping and then transcribed onto another transparent material. Bichromic acid gelatin, acrylic monomer-containing compounds and photoresists are used as the photosensitive material. The transparent materials are, for example, thermoplastic resins such as acrylic resins.

Page 4

Please amend paragraph [0009] to read as follows:

[0009] Patent Document 1: JP 2004-4417-A

Patent Document 2: JP Sho-59-131902-A

~~patent Document 3: JP 3413519-B~~ Patent Document 3: JP 2001-100621-A